

MOSFET

650V CoolMOS™ CE Power Transistor

CoolMOS™ is a revolutionary technology for high voltage power MOSFETs, designed according to the superjunction (SJ) principle and pioneered by Infineon Technologies. CoolMOS™ CE is a price-performance optimized platform enabling to target cost sensitive applications in Consumer and Lighting markets by still meeting highest efficiency standards. The new series provides all benefits of a fast switching Superjunction MOSFET while not sacrificing ease of use and offering the best cost down performance ratio available on the market.

1 2 3

Features

- Extremely low losses due to very low FOM Rdson*Qg and Eoss
- Very high commutation ruggedness
- Easy to use/drive
- · Pb-free plating, Halogen free mold compound
- Qualified for standard grade applications

Potential applications

PC Silverbox, Adapters, LCD & PDP TV and indoor Lighting

Please note: For MOSFET paralleling the use of ferrite beads on the gate or separate totem poles is generally recommended.



Gate





<u> </u>							
Parameter	Value	Unit					
V _{DS} @ T _{j,max}	700	V					
R _{DS(on),max}	1000	mΩ					
I _{d.typ}	7.2	A					
Q _{g.typ}	15.3	nC					
I _{D,pulse}	12	А					
E _{oss} @400V	1.5	μJ					



Drain

Source

Type / Ordering Code	Package	Marking	Related Links
IPS65R1K0CE	PG-TO 251-3	65S1K0CE	see Appendix A

650V CoolMOS™ CE Power Transistor IPS65R1K0CE



Table of Contents

escription1
1aximum ratings
hermal characteristics4
lectrical characteristics 5
lectrical characteristics diagrams
est Circuits
ackage Outlines
ppendix A
evision History
rademarks
nisclaimer

650V CoolMOS™ CE Power Transistor IPS65R1K0CE



1 Maximum ratings at $T_j = 25$ °C, unless otherwise specified

Table 2 Maximum ratings

Davamatav	Cumbal		Value	s	l lm!#	Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current ¹⁾	I _D	-	-	7.2 4.6	А	T _C =25°C T _C =100°C	
Pulsed drain current ²⁾	I _{D,pulse}	-	-	12	Α	T _C =25°C	
Avalanche energy, single pulse	E AS	-	-	50	mJ	I _D =1A; V _{DD} =50V; see table 10	
Avalanche energy, repetitive	E AR	-	-	0.15	mJ	I _D =1A; V _{DD} =50V; see table 10	
Avalanche current, repetitive	I _{AR}	-	-	1.0	Α	-	
MOSFET dv/dt ruggedness	dv/dt	-	-	50	V/ns	V _{DS} =0480V	
Gate source voltage (static)	V _{GS}	-20	-	20	V	static;	
Gate source voltage (dynamic)	V _{GS}	-30	-	30	V	AC (f>1 Hz)	
Power dissipation (TO252)	P _{tot}	-	-	68	W	T _C =25°C	
Storage temperature	$T_{ m stg}$	-55	-	150	°C	-	
Operating junction temperature	T _j	-55	-	150	°C	-	
Continuous diode forward current	Is	-	-	5.1	Α	T _C =25°C	
Diode pulse current ²⁾	I _{S,pulse}	-	-	12	Α	T _C =25°C	
Reverse diode dv/dt ³⁾	dv/dt	-	-	15	V/ns	$V_{\rm DS}$ =0400V, $I_{\rm SD}$ <= $I_{\rm S}$, $T_{\rm j}$ =25°C see table 8	
Maximum diode commutation speed	di _f /dt	-	-	500	A/μs	V_{DS} =0400V, I_{SD} <= I_{S} , T_{j} =25°C see table 8	

 $^{^{1)}}$ Limited by $T_{j\;max}.$ Maximum duty cycle D=0.50 $^{2)}$ Pulse width t_p limited by $T_{j,max}$ $^{3)}$ Identical low side and high side switch with identical \textit{R}_{G}

650V CoolMOS™ CE Power Transistor IPS65R1K0CE



2 Thermal characteristics

Table 3 Thermal characteristics

Devenuetor	Cumbal	Values			11:4	Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Thermal resistance, junction - case (TO252)	R _{thJC}	-	-	1.85	°C/W	-	
Thermal resistance, junction - ambient	R _{thJA}	-	-	62	°C/W	leaded	
Soldering temperature, wavesoldering only allowed at leads	T _{sold}	-	-	260	°C	1.6mm (0.063 in.) from case for 10s	

650V CoolMOS™ CE Power Transistor IPS65R1K0CE



3 Electrical characteristics

at T_j=25°C, unless otherwise specified

Table 4 Static characteristics

Baramatan	Oh l		Values			N
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	650	-	-	V	V_{GS} =0V, I_D =1mA
Gate threshold voltage	V _{(GS)th}	2.5	3.0	3.5	V	$V_{DS}=V_{GS}$, $I_{D}=0.2$ mA
Zero gate voltage drain current	I _{DSS}	-	- 10	1 -	μΑ	V _{DS} =650, V _{GS} =0V, T _i =25°C V _{DS} =650, V _{GS} =0V, T _i =150°C
Gate-source leakage current	I _{GSS}	-	-	100	nA	V _{GS} =20V, V _{DS} =0V
Drain-source on-state resistance	R _{DS(on)}	-	0.86 2.22	1.00	Ω	V _{GS} =10V, I _D =1.5A, T _j =25°C V _{GS} =10V, I _D =1.5A, T _j =150°C
Gate resistance	R _G	-	5.5	-	Ω	f=1MHz, open drain

Table 5 Dynamic characteristics

Barranatan	0	Values			T		
Parameter	Symbol	Min.	Тур. Мах.		Unit	Note / Test Condition	
Input capacitance	Ciss	-	328	-	pF	V _{GS} =0V, V _{DS} =100V, f=1MHz	
Output capacitance	Coss	-	23	-	pF	V _{GS} =0V, V _{DS} =100V, f=1MHz	
Effective output capacitance, energy related ¹⁾	C _{o(er)}	-	14	-	pF	V _{GS} =0V, V _{DS} =0480V	
Effective output capacitance, time related ²⁾	C _{o(tr)}	-	58.5	-	pF	I_D =constant, V_{GS} =0V, V_{DS} =0480V	
Turn-on delay time	$t_{\sf d(on)}$	-	6.6	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =2.2A, $R_{\rm G}$ =10.2 Ω ; see table 9	
Rise time	t _r	-	5.2	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =2.2A, $R_{\rm G}$ =10.2 Ω ; see table 9	
Turn-off delay time	$t_{ m d(off)}$	-	41	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =2.2A, $R_{\rm G}$ =10.2 Ω ; see table 9	
Fall time	t _f	-	13.6	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13 V, $I_{\rm D}$ =2.2A, $R_{\rm G}$ =10.2 Ω ; see table 9	

Table 6 Gate charge characteristics

Parameter	Cumbal		Values		Unit	Note / Test Condition	
	Symbol	Min.	Тур.	Max.	Unit		
Gate to source charge	Q_{gs}	-	1.8	-	nC	V_{DD} =480V, I_{D} =2.2A, V_{GS} =0 to 10V	
Gate to drain charge	$Q_{ m gd}$	-	8	-	nC	V_{DD} =480V, I_{D} =2.2A, V_{GS} =0 to 10V	
Gate charge total	Q_g	-	15.3	-	nC	V_{DD} =480V, I_{D} =2.2A, V_{GS} =0 to 10V	
Gate plateau voltage	V _{plateau}	-	5.4	-	V	V_{DD} =480V, I_{D} =2.2A, V_{GS} =0 to 10V	

 $^{^{1)}}$ $C_{\text{o(er)}}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 80% $V_{\text{o(BR)DSS}}$ $^{2)}$ $C_{\text{o(tr)}}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% $V_{\text{o(BR)DSS}}$

650V CoolMOS™ CE Power Transistor



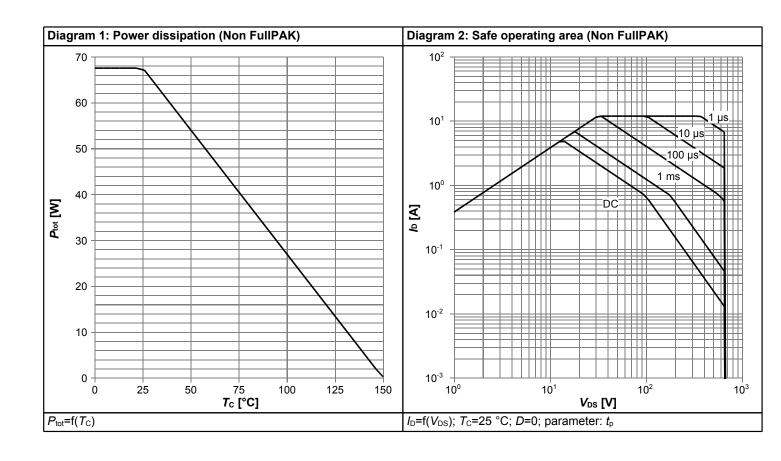


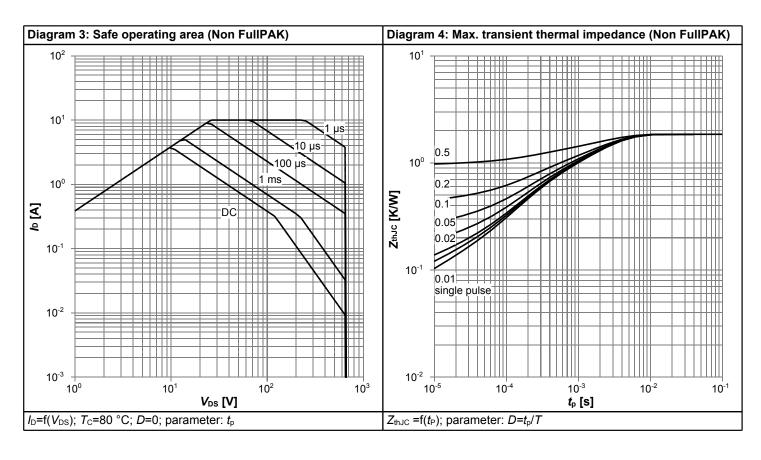
Table 7 Reverse diode characteristics

Parameter	Symbol	Values		Unit	Note / Test Condition	
raiailletei	Symbol	Min.	Тур.	Max.	Offic	Note / Test Condition
Diode forward voltage	V _{SD}	-	0.9	-	V	V _{GS} =0V, I _F =2.2A, T _j =25°C
Reverse recovery time	t _{rr}	-	226	-	ns	V_R =400V, I_F =2.2A, di_F/dt =100A/ μ s; see table 8
Reverse recovery charge	Qrr	-	1.3	-	μC	V_R =400V, I_F =2.2A, di_F/dt =100A/ μ s; see table 8
Peak reverse recovery current	I _{rrm}	-	9.9	-	Α	V_R =400V, I_F =2.2A, di_F/dt =100A/ μ s; see table 8

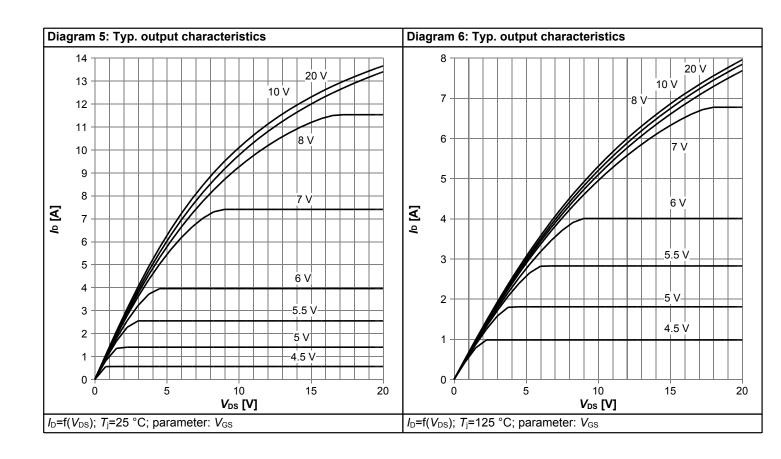


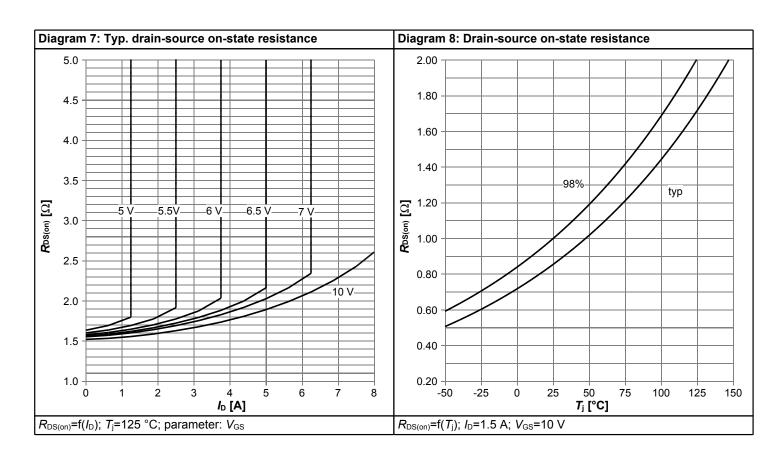
4 Electrical characteristics diagrams



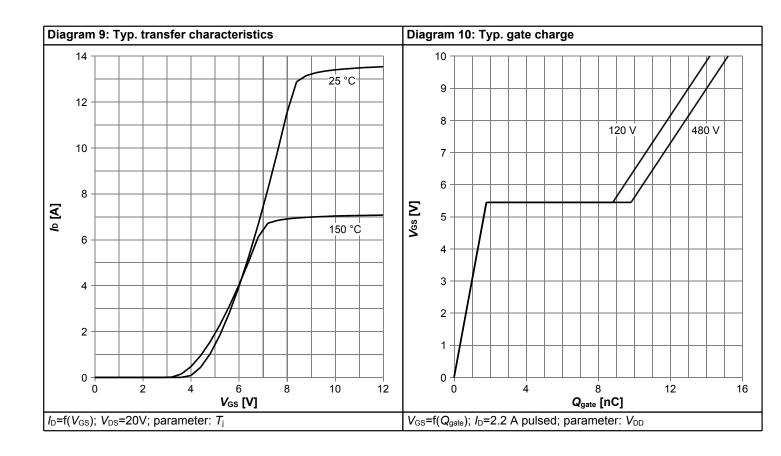


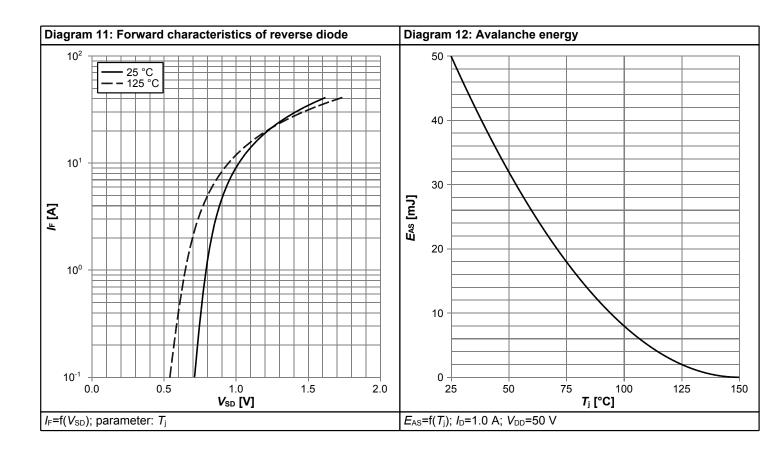




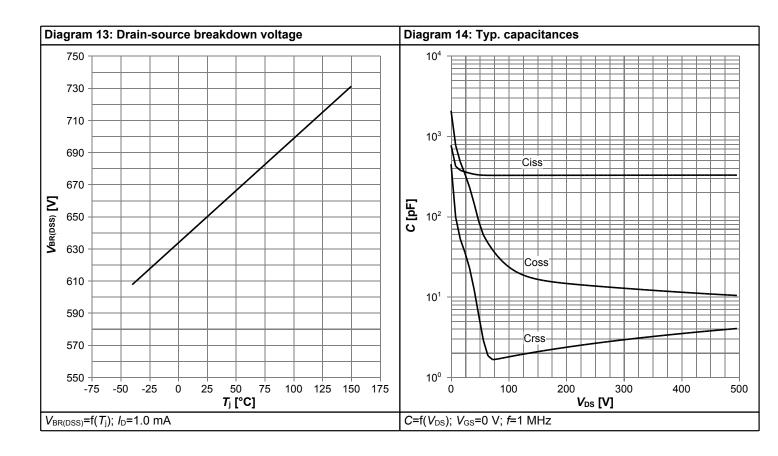


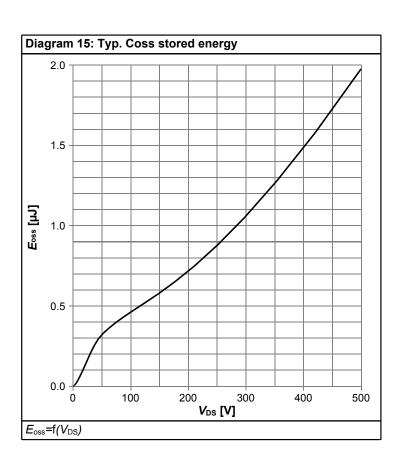














5 Test Circuits

Table 8 Diode characteristics

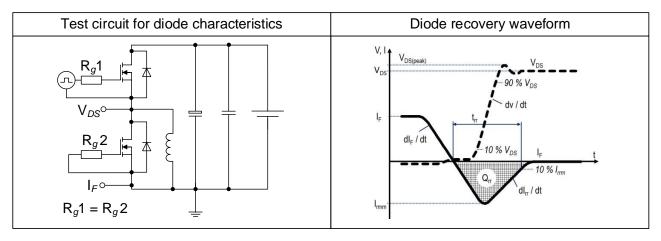


Table 9 Switching times

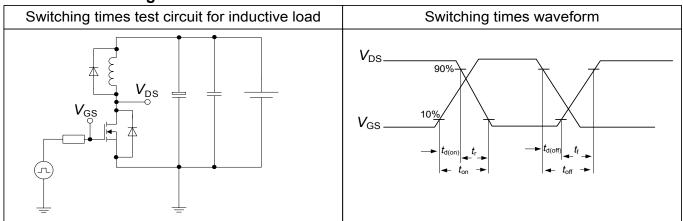
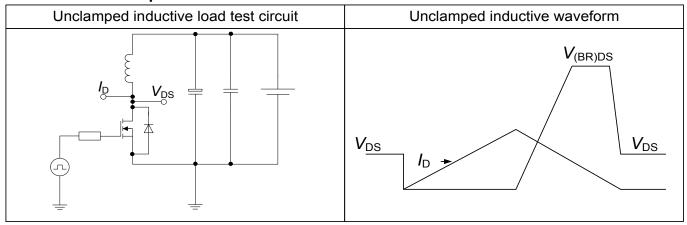
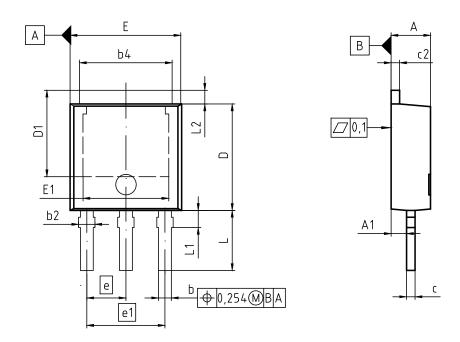


Table 10 Unclamped inductive load





6 Package Outlines



NOTES:

- 1. STANDARD QUALITY GRADE
- 2. ALL DIMENSIONS REFER TO JEDEC STANDARD TO-251 DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS.

DIM	MILLIN	IETERS	INC	IES	
DIW	MIN	MAX	MIN	MAX	
Α	2.20	2.40	0.087	0.094	
A1	0.90	1.14	0.035	0.045	
b	0.64	0.89	0.025	0.035	
b2	0.65	1.15	0.026	0.045	
b4	5.20	5.50	0.205	0.217	
С	0.46	0.60	0.018	0.024	
c2	0.46	0.60	0.018	0.024	
D	5.98	6.22	0.235	0.245	
D1	5.00	5.60	0.197	0.220	
E	6.35	6.73	0.250	0.265	
E1	4.63	5.21	0.182	0.205	
е	2	.29	0.090		
e1	4	.57	0.1	80	
N		3		3	
L	3.30	3.60	0.130	0.142	
L1	0.85	1.25	0.033	0.049	
L2	0.88	1.28	0.035	0.050	

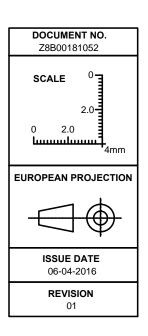


Figure 1 Outline PG-TO 251-3, dimensions in mm/inches

650V CoolMOS™ CE Power Transistor IPS65R1K0CE



7 Appendix A

Table 11 Related Links

• IFX CoolMOS™ CE Webpage: www.infineon.com

• IFX CoolMOS[™] CE application note: www.infineon.com

• IFX CoolMOS™ CE simulation model: www.infineon.com

• IFX Design tools: www.infineon.com

650V CoolMOS™ CE Power Transistor



Revision History

IPS65R1K0CE

Revision: 2017-07-25, Rev. 2.2

Previous Revision

Revision	Date	Subjects (major changes since last revision)				
2.0	2014-09-25	Release of final version				
2.1	2016-03-31	Modified Id, Rthjc. Modified SOA and Zthjc Curves				
2.2	2017-07-25	Updated package drawing on page 12				

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